

GS2GF~GS2MF

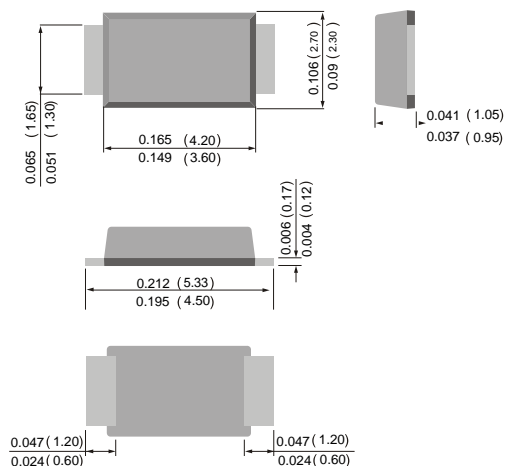
SURFACE MOUNT RECTIFIER

VOLTAGE 400~1000 Volts CURRENT 2 Amperes



SMAF

Unit : inch(mm)

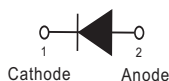


FEATURES

- For surface mounted applications in order to optimize board space
- Easy pick and place
- Plastic package has Underwriters Laboratory Flammability Classification 94V-O
- Low Forward Drop
- High temperature soldering : 260°C /10 seconds at terminals
- Glass Passivated Chip Junction
- Ultra Thin Profile Package for Space Constrained Utilization
- Package suitable for Automated Handling
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: SMAF molded plastic
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Standard packaging: 12mm tape (EIA-481)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

PARAMETER	SYMBOL	GS2GF	GS2JF	GS2KF	GS2MF	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	400	600	800	1000	V
Maximum Average Forward Current	$I_{F(AV)}$	2				A
Peak Forward Surge Current : 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	60				A
Maximum Forward Voltage at 2A	V_F	1.1				V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	5				μA
Typical Junction Capacitance ($V_R=4V, f=1MHz$)	C_J	18				pF
Typical Thermal Resistance (Notes 1) (Notes 2)	$R_{\theta JL}$ $R_{\theta JA}$	25 150				$^{\circ}C/W$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150				$^{\circ}C$

NOTES : 1. Mounted on an FR4 PCB, single-sided copper, with 100cm² copper pad area
2. Mounted on an FR4 PCB, single-sided copper, mini pad.

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RATING AND CHARACTERISTIC CURVES

